

RoHS COMPLIANT

QM3006M6-VB Datasheet N-Channel 30 V (D-S) MOSFET

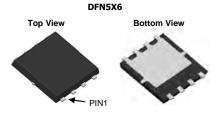
PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{a, e} Q _g (Typ				
30	0.003 at V _{GS} = 10 V	120	71 nC			
	0.005 at V _{GS} = 4.5 V	90	7110			

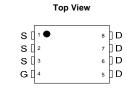
FEATURES

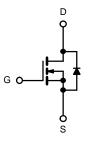
- Trench Power MOSFET
- ٠ 100 % R_g and UIS Tested

APPLICATIONS

- Notebook PC Core
- VRM/POL •







N-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		120 ^{a, e}	
Continuous Drain Current (T _J = 175 °C)	T _C = 70 °C		90 ^e	
Continuous Drain Current (1) = 175 C)	T _A = 25 °C	I I _D	21 ^{b, c}	A
	T _A = 70 °C		20.8 ^{b, c}	
Pulsed Drain Current	I _{DM}	250		
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	56	
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	60	mJ
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	80 ^{a, e}	Α
Continuous Source-Drain Diode Current	T _A = 25 °C	'5	76 ^{b, c}	
	T _C = 25 °C		210 ^a	
Maximum Power Dissipation	T _C = 70 °C	P _D	155	w
Maximum Power Dissipation	T _A = 25 °C		35 ^{b, c}	vv
	T _A = 70 °C		13 ^{b, c}	
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	$t \le 10 \text{ s}$	R _{thJA}	41	50	°C/W		
Maximum Junction-to-Case	Steady State	R _{thJC}	0.7	0.9	- C/W		

Notes:

a. Based on $T_C = 25 \text{ °C}$. b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 90 °C/W.
e. Calculated based on maximum junction temperature. Package limitation current is 80 A.

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted) Parameter Symbol Test Conditions Min . Typ. Max. Unit								
Symbol	Test Conditions	Min .	Тур.	Max.	Unit			
		1	Т	1	I			
	V _{GS} = 0 V, I _D = 250 μA	30			V			
	I _D = 250 μA				mV/°0			
			- 5.5					
V _{GS(th)}		1.0		2.5	V			
I _{GSS}				± 100	nA			
loco				1	μA			
'D88	V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C			10				
I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	80			A			
P	V _{GS} = 10 V, I _D = 32 A		0.003		Ω			
™DS(on)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 29 \text{ A}$		0.005					
ansconductance ^a g_{fs} $V_{DS} = 15 \text{ V}, I_D = 32 \text{ A}$			130		S			
		•	•					
C _{iss}				3200	pF			
	V _{DS} = 12.5 V, V _{GS} = 0 V, f = 1 MHz			1025				
				970				
	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 32 A			71	nC			
Q _g <u>50 50 5</u>				61.5				
Q _{qs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 29 \text{ A}$			34				
				29				
	f = 1 MHz		1.4	2.1	Ω			
•			18	27				
t _r	V _{DD} = 15 V, R _I = 0.555 Ω		11	17	-			
t _{d(off)}	$I_D \cong 27 \text{ A}, V_{GEN} = 10 \text{ V}, \text{R}_g = 1 \Omega$		70	105				
			10	15				
			55	83	ns			
	$V_{DD} = 15 \text{ V. } \text{R}_1 = 0.625 \Omega$		180	270				
	55 2		55	83				
				18				
	T _C = 25 °C			80				
-	~		1		A			
	I _S = 22 A		0.8		V			
-	<u> </u>				ns			
					nC			
	$I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$			100				
t _a			27		ns			
	Symbol V_{DS} $\Delta V_{DS}/T_J$ $\Delta V_{GS}(th)/T_J$ $V_{GS}(th)/T_J$ $V_{GS}(th)/T_J$ I_{DSS} I_{DSS} I_{DSS} $I_{D(n)}$ $R_{DS(on)}$ gfs C_{iss} C_{oss} C_{rss} Q_g Q_{gs} Q_{gd} R_g $t_{d(on)}$ t_r $t_{d(off)}$ t_r $t_{d(off)}$ t_r $t_{d(off)}$ t_r t_{SD} I_{SM} V_{SD} t_r I_s I_s I_s I_s	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS}(th)/T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline V_{DS}(h) & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = 4.20 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 10 \ V, \ I_D = 32 \ A \\ \hline V_{CS} = 10 \ V, \ I_D = 32 \ A \\ \hline V_{CS} = 10 \ V, \ I_D = 32 \ A \\ \hline V_{DS} = 15 \ V, \ I_D = 32 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 32 \ A \\ \hline U_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 29 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 29 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 29 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 32 \ A \\ \hline U_{DD} = 15 \ V, \ R_L = 0.555 \ \Omega \\ \hline I_d(on) & I_T & V_{DD} = 15 \ V, \ R_L = 0.625 \ \Omega \\ \hline I_D \cong 27 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 24 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 24 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_T & I_S & T_C = 25 \ ^{\circ}C \\ \hline I_{SM} & V_{SD} & I_S = 22 \ A \\ \hline I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^{\circ}C \\ \hline I_SM & V_{SD} & I_S = 22 \ A \\ \hline I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^{\circ}C \\ \hline I_SM & V_{SD} & I_S = 22 \ A \\ \hline I_T & I_F & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^{\circ}C \\ \hline I_SM & I_F = 20 \ A, \ di/dt = 100 \ A/\mu s, \ T_J = 25 \ ^{\circ}C \\ \hline I_S & I_S & I_S & I_S = 22 \ A \\ \hline I_T & I_F & I_S & I_S & I_S & I_S = 22 \ A \\ \hline I_T & I_F & I_S & I_$	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions & Min . \\ \hline & & & & & & & & & & & & & & & & & &$	$\begin{array}{ c c c c c c } \hline Symbol & Test Conditions & Min. Typ. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 & 35 & 36 & 36 & 36 & 36 & 36 & 36 & 36$	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. & Typ. & Max. \\ \hline V_{DS} & V_{GS} = 0 V, I_D = 250 \ \mu A & 30 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 & -5.5 &$			

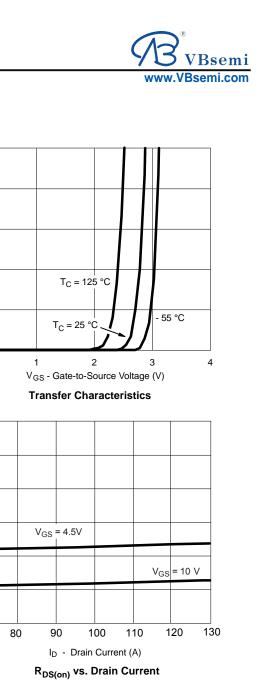
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

3.0

2.4

1.8

1.2

0.6

0.0

0.012

0.010

0.008

0.006

0.004

0.002

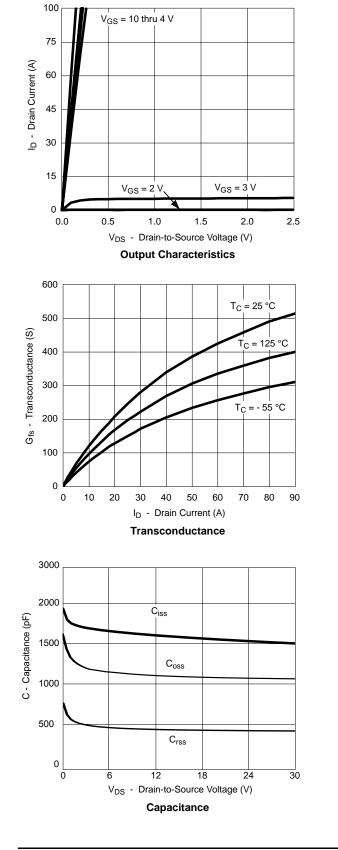
0.000

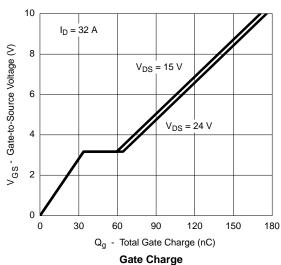
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 $R_{DS(on)}$ – On-Resistance (Ω)

0

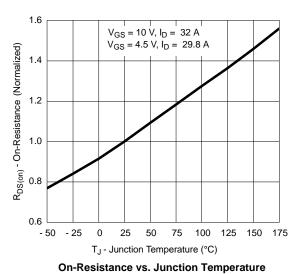
I_D - Drain Current (A)



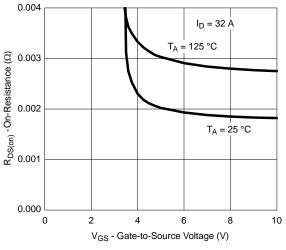


服务热线:400-655-8788

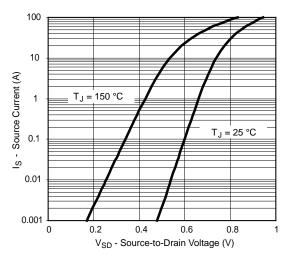




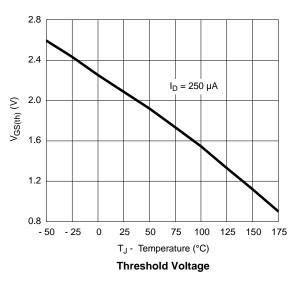
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

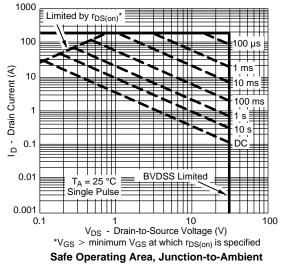


 $R_{\text{DS(on)}}$ vs. V_{GS} vs. Temperature

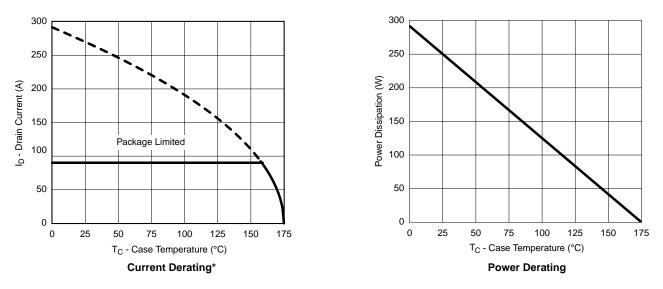


Forward Diode Voltage vs. Temperature



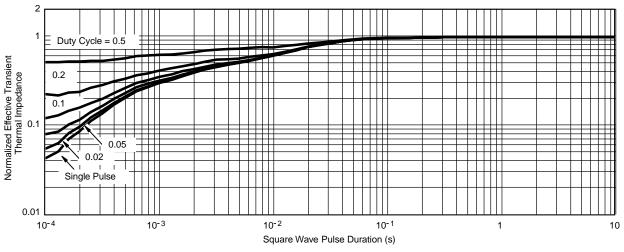






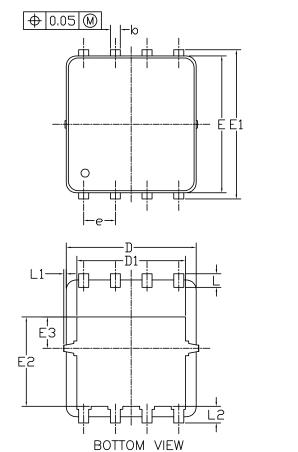
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

* The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

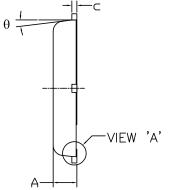


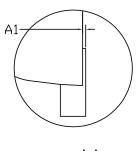
Normalized Thermal Transient Impedance, Junction-to-Case





DFN5x6_8L_EP1_P PACKAGE OUTLIN





<u>VIEW 'A'</u> (SCALE 5:1)

RECOMMENDED LAND PATTERN .60 -0.55 0.50 -0.77 -0.635 4.12 6.15 -1.60 + 0.65 +|+| + ŧ -11.27-0.50-

CNA (DOL 6	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
A	0.85	0.95	1.00	0.033	0.037	0.039
Al	0.00		0.05	0.000		0.002
b	0.30	0.40	0.50	0.012	0.016	0.020
с	0.15	0.20	0.25	0.006	0.008	0.010
D	5.10	5.20	5.30	0.201	0.205	0.209
D1	4.25	4.35	4.45	0.167	0.171	0.175
Е	5.45	5.55	5.65	0.215	0.219	0.222
E1	5.95	6.05	6.15	0.234	0.238	0.242
E2	3.525	3.625	3.725	0.139	0.143	0.147
E3	1.175	1.275	1.375	0.046	0.050	0.054
e	1.27 BSC				0.050 BSC	
L	0.45	0.55	0.65	0.018	0.022	0.026
L1	0		0.15	0		0.006
L2	0.68 REF				0.027 REF	
θ	0°		10°	0°		10°

UNIT: mm

01111.11111

 PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS. MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH.
CONTROLLING DIMENSION IS MILLIMETER.

CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

NOTE



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